

QT-Brightek Chip LED Series 0402 SMD Chip LED

Part No.: QBLP595-2IB

Product: QBLP595-2IB	Date: February 21, 2025	
	Version# 1.1	



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Introduction

Feature:

- Water clear lens
- Package in tape and reel
- Compact 0402 package
- InGaN technology
- Viewing angle: 140° typ.
- Height profile: 0.5mm

Application:

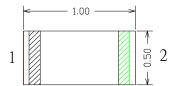
- Status indication
- Back lighting application

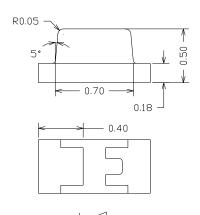
Certification & Compliance:

- ISO9001
- RoHS Compliant



Dimension:





Units: mm / tolerance = +/-0.1mm

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Electrical / Optical Characteristic (Ta=25 °C)

Product	Color	I _F (mA)	V _F	(V)		λ _D (nm))	λ _P (nm)	I _V (n	ncd)
Floudet	Coloi	IF (IIIA)	Тур.	Max.	Min.	Тур.	Max.	Тур.	Min.	Тур.
QBLP595-2IB	Blue	20	3.2	3.7	460	465	470	460	32	60

Absolute Maximum Rating

Material	P _d (mW)	I _F (mA)	I _{FP} (mA)*	V _R (V)	T _{OP} (°C)	T _{ST} (°C)	T _{SOL} (°C)**
InGaN	111	30	100	5	-40 ~ +80	-40 ~ +85	260

^{*}Duty 1/10 @ 1kHz

Forward Voltage V_F @ I_F=20mA

Bin	Min.	Max.	Unit
f	2.8	3.1	
g	3.1	3.4	V
h	3.4	3.7	

Luminous Intensity I_V @ I_F=20mA

Bin	Min.	Max.	Unit
E	32	40	
F	40	50	
G	50	63	mcd
Н	63	80	
I	80	100	

Dominant Wavelength λ_D @ I_F =20mA

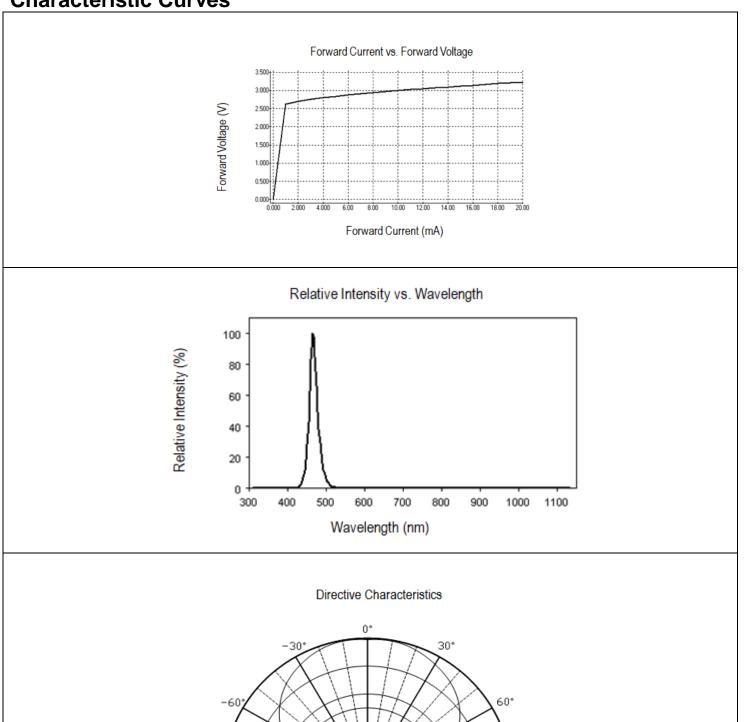
Bin	Min.	Max.	Unit
E	460	462.5	
F	462.5	465	nm
G	465	467.5	nm
Н	467.5	470	

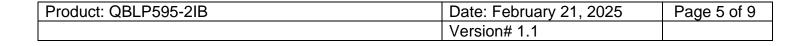
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^{**}IR Reflow for no more than 10 sec @ 260 °C



Characteristic Curves





100%

50%

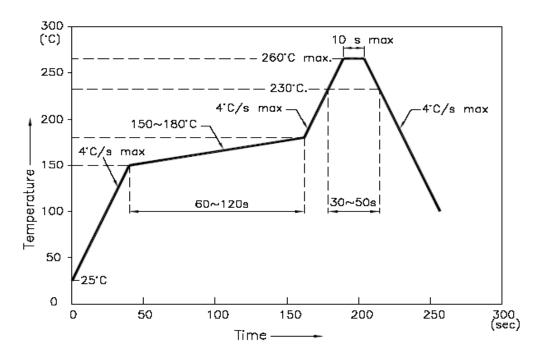
50%

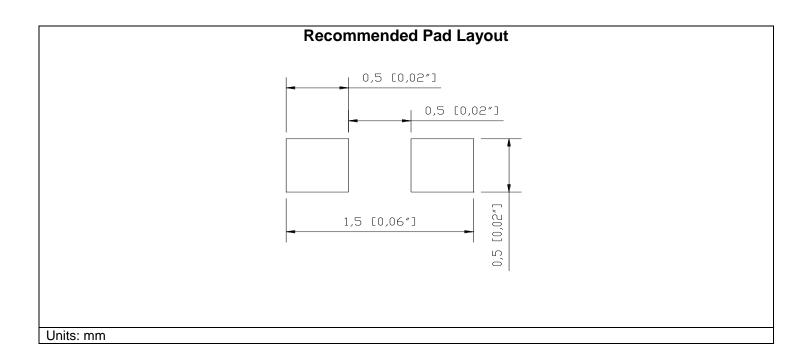
100%



Solder Profile & Footprint

-The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



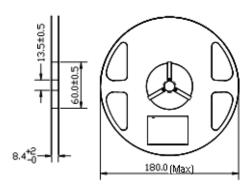


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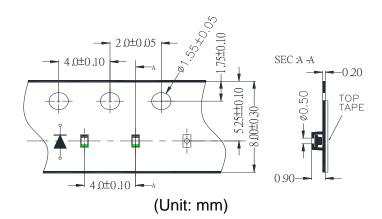
Packing

Reel Dimension:

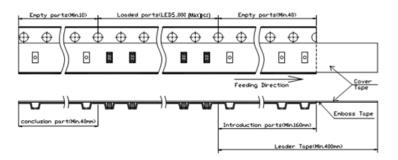


(Unit: mm)

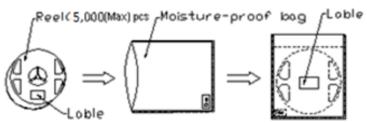
Tape Dimension:



Arrangement of Tape:



Packaging Specifications:



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Labeling

Part No:
Customer P/N:
ltem:
Q'ty:
Vf:
lv:
WI:
Date: Made in China

Ordering Information

Orderable Part #	Spec Range	Quantity per reel
QBLP595-2IB	Iv=60mcd typ. @ 20mA, λ_D =460nm to 470nm	5,000 units

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Revision History

Description:	Revision #	Revision Date
New Release of QBLP595-2IB	V1.0	08/13/2023
Update typical WLD and WLP	V1.1	02/21/2025

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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